



		Search Text		Time stamp
Number	Hits	(etch\$3 or remov\$3) same (copper or "cu")		2002/11/18 11:42
	89661	(etch\$3 of femov\$5) same (ooppor or any	US-PGPUB;	
	İ		EPO; JPO;	
		(etch\$3 or remov\$3 or mill\$3) same (copper or "cu")	DERWENT;	
			IBM_TDB	
			USPAT;	2002/11/18 11:46
2	96544	(etch\$3 or remov\$5 or milit\$5) same (especially)	US-PGPUB;	
			EPO; JPO;	
	į		DERWENT;	
			IBM_TDB	
4	12983	(halogen or iodine) same (copper or "cu")	USPAT;	2002/11/18 11:47
			US-PGPUB;	1
	Ţ		EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	2357	((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and ((halogen or iodine) same (copper or "cu"))	USPAT;	2002/11/18 11:47
			US-PGPUB;	
			EPO; JPO;	1
			DERWENT;	
			IBM_TDB	
5		and (conner or "cu")) and	USPAT;	2002/11/18 11:51
	613	(((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and ((halogen or iodine) same (copper or "cu"))) and (reaction near	US-PGPUB;	
		((halogen or lodine) same (copper of cd //) and (redeleter)	EPO; JPO;	
		product)	DERWENT;	
			IBM_TDB	
6		and conner or "cu")) and	USPAT;	2002/11/18 12:03
	0	((((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and ((halogen or iodine) same (copper or "cu"))) and (reaction near		
			EPO; JPO;	
7		product)) and (focused near ion near beam or "FIB")	DERWENT;	
			IBM_TDB	
		and (coppor or "cu")) and	USPAT;	2002/11/18 14:1
	4	(((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and ((halogen or iodine) same (copper or "cu"))) and (focused near ion near beam or "FIB")		İ
			EPO; JPO;	Ì
			DERWENT;	
			IBM TDB	
		was (appear or "qui")) and	USPAT;	2002/11/18 12:0
8	15	((((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and		•
_	1	((((etch\$3 or remov\$5 or min\$5) same (copper or "cu"))) and (reaction near product)) and (ion near beam)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	Ì
9	7	((((((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and	USPAT;	2002/11/18 12:0
			1	
	Ţ	((((etch\$3 of remov\$3 of million)))) and (reaction near ((halogen or iodine) same (copper or "cu"))) and (reaction near (halogen or iodine))	EPO; JPO;	
	1.	product)) and (ion near beam)) and @pd<20010622	DERWENT;	
	1		IBM_TDB	i
	1	(vaporiz\$3)	USPAT;	2002/11/18 14:
10	19	(focused near ion near beam) same (vaporiz\$3)	US-PGPUB	
	l	the arm's arms (/romov\$3 or mill\$3 or	USPAT;	2002/11/18 13:
11	25	(focused near ion near beam) same ((remov\$3 or mill\$3 or	US-PGPUB	;
		etch\$3) same copper)	EPO; JPO;	´
			DERWENT	:
1	25	((focused near ion near beam) same ((remov\$3 or mill\$3 or etch\$3) same copper)) and 2pd<20010622	IBM_TDB	
			USPAT;	2002/11/18 13:
12			US-PGPUB	l l
			EPO; JPO;	
	<u> </u>		DERWENT	·
			IBM_TDB	
1		//	USPAT;	2002/11/18 13
13	1	3 ((focused near ion near beam) same ((remov\$3 or mill\$3 or	US-PGPUE	
		etch\$3) same copper)) and @pd<20010622	EPO; JPO;	
	ľ		DERWENT	
			IBM_TDB	
	1	Living the support	USPAT:	2002/11/18 14
22	1	0 (copper near iodine or copper near chloride) same (focused	US-PGPU	
		near ion near beam or "FIB")		





23	0	(copper near iodine) same (focused near ion near beam or "FIB")	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/11/18 14:16
24	43	(((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and ((halogen or iodine) same (copper or "cu"))) and (ion near beam or "FIB")	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/18 14:21
25	1	((((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and ((halogen or iodine) same (copper or "cu"))) and (ion near beam or "FIB")) and vaporiz\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/11/18 14:20
26	23	((((etch\$3 or remov\$3 or mill\$3) same (copper or "cu")) and ((halogen or iodine) same (copper or "cu"))) and (ion near beam or "FIB")) and @pd<20010622	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/18 14:24